

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|---|---|------------------|---------|------------------|
| L1 | 2 | ("5324766").PN. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/31 13:14 |
| L2 | 5 | ("2717734").PN. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/31 13:22 |
| L4 | 717 | (nishida and masahiro).in. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/31 13:23 |
| L5 | 151 | (ishibashi and tatsuo).in. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/31 13:23 |
| L6 | 38 | (okumura and shuzo).in. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/31 13:23 |
| S1 | 3 | "6713161" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/31 13:03 |
| S2 | 4 | (electromagnetic with (sheild\$3 or wave-sheild\$3 or radiation-sheild\$3)).clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:12 |
| S3 | 3 | (electromagnetic with (sheild\$3 or wave-sheild\$3 or radiation-sheild\$3)).ti. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:21 |
| S4 | 9 | ((electromagnetic or radiation) with (sheild\$3 or wave-sheild\$3 or radiation-sheild\$3)).clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:12 |

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| S5 | 42 | (microwave adj shielding).clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:32 |
| S6 | 686 | (radiation adj shielding).clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:22 |
| S7 | 2 | S6 and (etch\$3 and \$7plating and \$5resist).clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:24 |
| S8 | 808 | (428/203).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:24 |
| S9 | 2906 | (428/209).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:25 |
| S10 | 1191 | (216/41).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:25 |
| S11 | 992 | (216/100).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:25 |
| S12 | 386 | (428/548).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:30 |
| S13 | 1250 | (428/418).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:30 |
| S14 | 395 | (216/12).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:30 |

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| S15 | 88 | S14 and transparent | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:31 |
| S16 | 48 | S14 and transparent.clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:31 |
| S17 | 12 | ((electromagnetic or radiation) near2 shield\$3) and (light-transmitting or (light adj transmitting) or transparent) and plat\$3 and (resist or photoresist or mask\$3) and etch\$3).clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/04/22 17:32 |
| S18 | 1 | ("5324766").PN. | US-PGPUB; USPAT; USOCR | OR | OFF | 2005/05/30 19:14 |
| S19 | 809 | (428/203).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:43 |
| S20 | 2922 | (428/209).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:22 |
| S21 | 1201 | (216/41).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:22 |
| S22 | 994 | (216/100).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:22 |
| S23 | 391 | (428/548).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:22 |
| S24 | 1253 | (428/418).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:22 |

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| S25 | 398 | (216/12).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:22 |
| S26 | 67 | (S19 or S20 or S21 or S22 or S23 or S24 or S25) and (electroplat\$3 and etch\$3).clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:23 |
| S27 | 551 | etch\$3 and (electroplat\$3 or electroless) and ((resin or polymer or plastic) with hydrophilic) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:28 |
| S28 | 11 | etch\$3 and (electroplat\$3 or electroless) and ((resin or polymer or plastic) with hydrophilic) | JPO | OR | OFF | 2005/05/30 19:47 |
| S29 | 8 | (etch\$3 and (electroplat\$3 or electroless) and ((resin or polymer or plastic) with hydrophilic)).clm. | US-PGPUB; USPAT | OR | OFF | 2005/05/30 19:28 |
| S30 | 2 | etch\$3 and (electroplat\$3 or electroless) and (resin or polymer or plastic) and hydrophilic and \$resist | JPO | OR | OFF | 2005/05/30 19:38 |
| S31 | 5 | (etch\$3 and (electroplat\$3 or electroless) and (resin or polymer or plastic) and hydrophilic and \$resist).clm. | US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:38 |
| S32 | 908 | (etch\$3 and (electroplat\$3 or electroless) and (resin or polymer or plastic) and hydrophilic and \$resist) | US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:38 |
| S33 | 1253 | (428/418).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:43 |
| S34 | 391 | (428/548).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:43 |
| S35 | 1031 | (524/431).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:44 |

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| S36 | 376 | (264/1.33).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:44 |
| S37 | 855 | (264/1.7).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:44 |
| S38 | 744 | (264/210.2).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:44 |
| S39 | 203 | (427/418).CCLS. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:44 |
| S40 | 6 | ("3753710" "3773514" "3775157" "3839037" "3874879" "3900320").PN. | US-PGPUB; USPAT; USOCR | OR | OFF | 2005/05/30 19:45 |
| S41 | 0 | ((etch\$3 or remov\$3) and (plat\$3 or electroplat\$3 or electroless)). clm. and ((resin or polymer or plastic) with hydrophilic) | JPO | OR | OFF | 2005/05/30 19:48 |
| S42 | 740 | ((etch\$3 or remov\$3) and (plat\$3 or electroplat\$3 or electroless)). clm. and ((resin or polymer or plastic) with hydrophilic) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:48 |
| S43 | 528 | ((etch\$3 or remov\$3) and (plat\$3 or electroplat\$3 or electroless)). clm. and ((resin or polymer or plastic) near3 hydrophilic) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:48 |
| S44 | 439 | ((etch\$3 or remov\$3) and (plat\$3 or electroplat\$3 or electroless)). clm. and ((resin or polymer or plastic) near2 hydrophilic) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:49 |
| S45 | 145 | S44: not (lithographic or (printing adj plate\$1)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:50 |

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| S46 | 160 | S43 not (lithographic or (printing adj plate\$1)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:52 |
| S47 | 72 | black adj (electroplat\$3 or electroless) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2005/05/30 19:53 |